

isc N-Channel MOSFET Transistor

SQ2318AES

• FEATURES

- Low drain-source on-resistance:
 $R_{DS(on)} \leq 45\text{m}\Omega$
- Fast Switching Speed
- 100% avalanche tested
- Minimum Lot-to-Lot variations for robust device performance and reliable operation

• DESCRIPTION

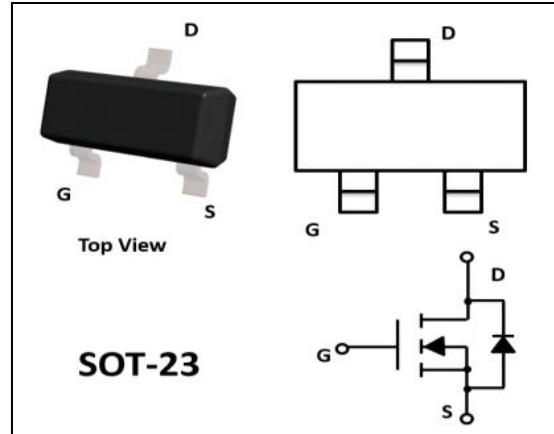
- Provides the designer with an extremely efficient and reliable device for use in battery and load management.

• ABSOLUTE MAXIMUM RATINGS($T_a=25^\circ\text{C}$)

SYMBOL	PARAMETER	VALUE	UNIT
V_{DSS}	Drain-Source Voltage	40	V
V_{GS}	Gate-Source Voltage	± 20	V
I_D	Drain Current-Continuous@ $T_a=25^\circ\text{C}$	5	A
I_{DM}	Drain Current-Single Pulsed	20	A
P_D	Total Dissipation @ $T_a=25^\circ\text{C}$	1.2	W
T_j	Max. Operating Junction Temperature	-55~150	°C
T_{stg}	Storage Temperature	-55~150	°C

• THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	MAX	UNIT
$R_{th(ch-a)}$	Channel-to-ambient thermal resistance	104	°C/W



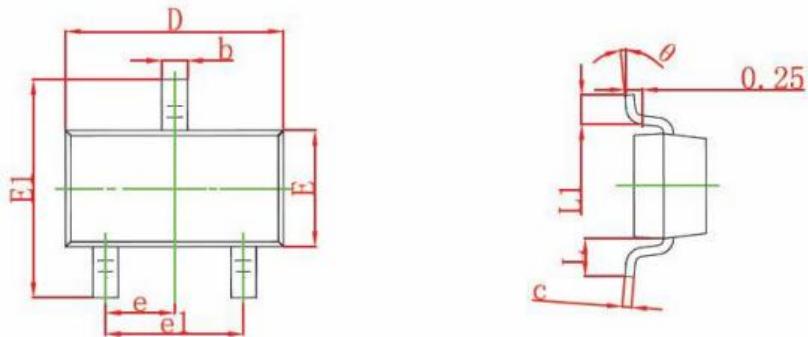
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ELECTRICAL CHARACTERISTICS

$T_c=25^\circ\text{C}$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}; I_D = 250 \mu\text{A}$	40			V
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}; I_D = 250 \mu\text{A}$	1		2.5	V
$R_{\text{DS(on)}}$	Drain-Source On-Resistance	$V_{\text{GS}}=10\text{V}; I_D=5\text{A}$			45	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}; I_D= 3\text{A}$			60	
I_{GSS}	Gate-Source Leakage Current	$V_{\text{GS}}= \pm 20\text{V}; V_{\text{GS}}=0\text{V}$			± 100	nA
		$V_{\text{GS}}= \pm 10\text{V}; V_{\text{GS}}=0\text{V}$			± 50	
I_{DSS}	Drain-Source Leakage Current	$V_{\text{DS}}= 40\text{V}; V_{\text{GS}}= 0\text{V}$			1	μA
V_{SD}	Diode forward voltage	$I_S=5\text{A}; V_{\text{GS}} = 0\text{V}$			1.2	V
C_{iss}	Input Capacitance	$V_{\text{DS}}=20\text{V}; V_{\text{GS}}=10\text{V}; I_D=3.5\text{A}$		490		pF
C_{oss}	Output Capacitance			92		pF
C_{rss}	Reverse Transfer Capacitance			68		pF
Q_g	Total Gate Charge	$V_{\text{DS}}=480\text{V}; I_D=38\text{A}; V_{\text{GS}}=10\text{V}$		5.2		nC
Q_{gs}	Gate-Source Charge			0.9		nC
Q_{gd}	Gate-Drain Charge			1.3		nC
$t_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{GS}}=10\text{V}; V_{\text{DD}}=20\text{V}; R_{\text{GEN}}= 3 \Omega ; R_L= 2 \Omega$		13		nS
t_r	Turn-on Rise Time			52		nS
$t_{\text{d(off)}}$	Turn-Off Delay Time			17		nS
t_f	Turn-Off Fall Time			10		nS

isc N-Channel MOSFET Transistor**SQ2318AES****SOT-23 Package information**

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP		0.037 TYP	
e1	1.800	2.000	0.071	0.079
L	0.550 REF		0.022 REF	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°

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